Silicon PNP Epitaxial

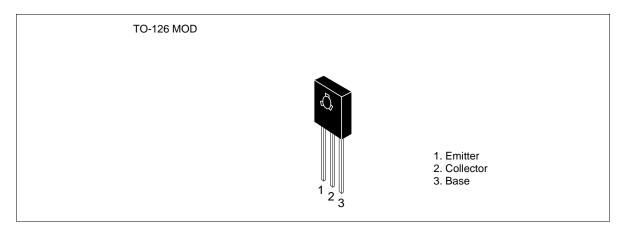
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ADE-208-853 (Z) 1st. Edition Sep. 2000

#### Application

Low frequency power amplifier complementary pair with 2SC1212 and 2SC1212A

## Outline



## **Absolute Maximum Ratings** (Ta = 25°C)

		Ratings			
Item	Symbol	2SA743	2SA743A	Unit	
Collector to base voltage	V <sub>CBO</sub>	-50	-80	V	
Collector to emitter voltage	V <sub>CEO</sub>	-50	-80	V	
Emitter to base voltage	V <sub>EBO</sub>	-4	-4	V	
Collector current	I <sub>c</sub>	-1	-1	А	
Collector power dissipation	Pc	0.75	0.75	W	
	Pc*1	8	8		
Junction temperature	Tj	150	150	°C	
Storage temperature	Tstg	-55 to +150	-55 to +150	°C	

Note: 1. Value at  $T_c = 25^{\circ}C$ .



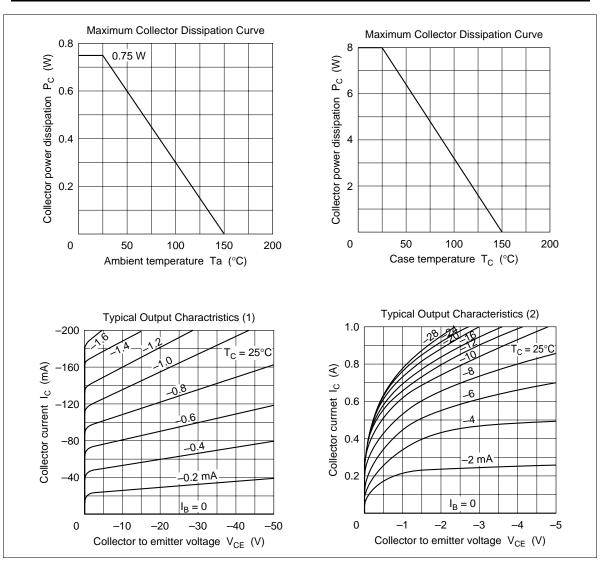
		2SA7	43		2SA743A				
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(\text{BR})\text{CBO}}$	-50	—	_	-80	—	_	V	$I_{c} = -1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-50	—	_	-80	—	—	V	$I_c = -10 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-4	—	_	-4	—	_	V	$I_{\rm E} = -1$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CER</sub>	—	—	-20	—	—	—	μA	$V_{ce} = -50 \text{ V}, \text{ R}_{be} = 1 \ \text{k}\Omega$
	I <sub>CER</sub>	_	—	_	_	—	-20	_	$V_{ce} = -80$ V, $R_{be} = 1$ k $\Omega$
DC current tarnsfer ratio	$h_{\rm FE}^{*1}$	60	120	200	60	120	200		$V_{ce} = -4 V, I_c = -50 mA$
	h <sub>FE</sub>	20	_		20	—	—	_	$V_{CE} = -4 \text{ V}, \text{ I}_{C} = -1 \text{ A}$ (pulse)
Base to emitter voltage	$V_{BE}$	_	-0.65	-1.0	_	-0.65	1.0	V	$V_{ce} = -4 V, I_c = -50 mA$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	-0.75	-1.5	—	-0.75	-1.5	V	$I_{\rm c} = -1$ A, $I_{\rm B} = -0.1$ A
Gain bandwidth product	f <sub>T</sub>	_	120	—	—	120	_	MHz	$V_{ce} = -4 V, I_c = -30 mA$

### **Electrical Characteristics** (Ta = 25°C)

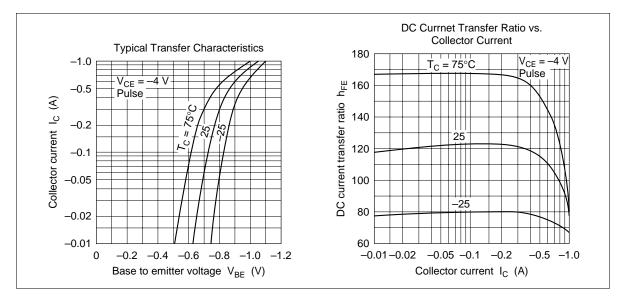
Note: 1. The 2SA743 and 2SA743A is grouped by  $\rm h_{\rm FE}$  as follows.

 B
 C

 60 to 120
 100 to 200



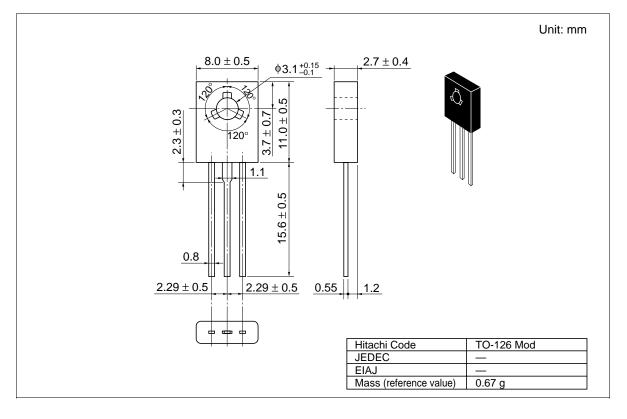
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## **Package Dimensions**

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#### **Package Dimensions**



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